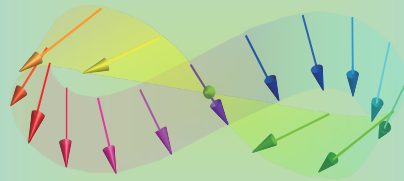


Information Storage and Spintronics

16



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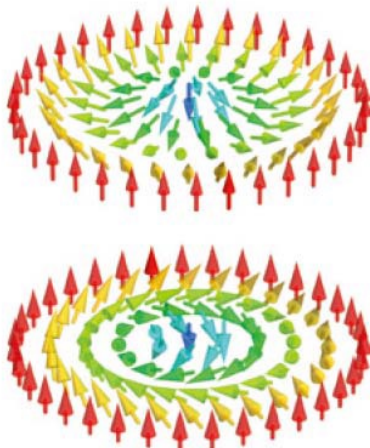


14:00 Friday, 25/November/2022 (SLB 101)

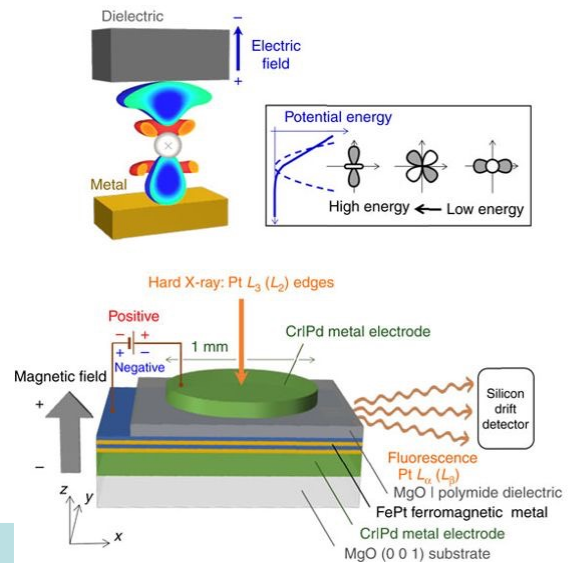


Quick Review over the Last Lecture

Magnetic skyrmions : *



Voltage-controlled memory : *



	Skyrmions	Domain walls
Size [nm]		
Velocity [m/s]		
Critical current density [A/cm ²]		

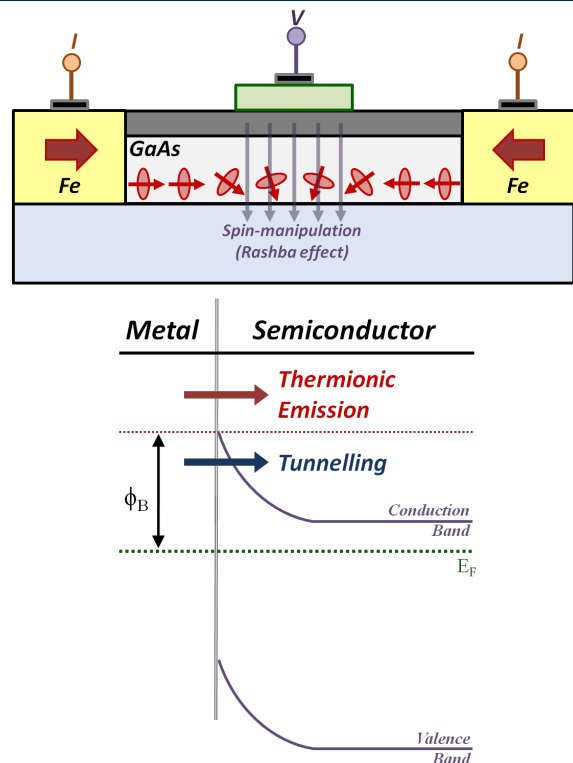
* A. Fert *et al.*, *Nature Nanotechnol.* **8**, 152 (2013);
 ** S. Miwa *et al.*, *Nat. Commun.* **8**, 15848 (2017).

16 Three-Terminal Devices

- Spin-polarised transistors
 - Lateral spin-valves
 - Spin injection
 - Spin accumulation
 - Johnson transistors

Spin-Polarised Field Effect Transistor

- Spin transistor was originally proposed by Datta and Das.
- Fe/GaAs is one of the leading systems for obtaining efficient spin-polarised injection into a semiconductor (SC). **
- GaAs has long carrier spin lifetimes and large spin diffusion lengths.
- Fe is an ideal injector as it has:
 - high Curie temperature
 - low coercivity
 - good lattice matching with GaAs
- The intrinsic Schottky barrier that forms at the Fe/SC interface overcomes the limitations due to the conductivity mismatch.

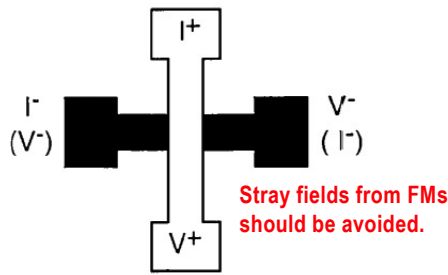


* S. Datta and S. Das, *Appl. Phys. Lett.* **56**, 665 (1990);
 ** G. Wastlbauer and J. A. C. Bland, *Adv. Phys.* **54**, 137 (2005); D. Hagele *et al.*, *Appl. Phys. Lett.* **73**, 1580 (1998);
 J. M. Kikkawa and D.D. Awschalom, *Nature* **397**, 139 (1999); E. I. Rashba, *Phys. Rev. B* **62**, R16267 (2000).

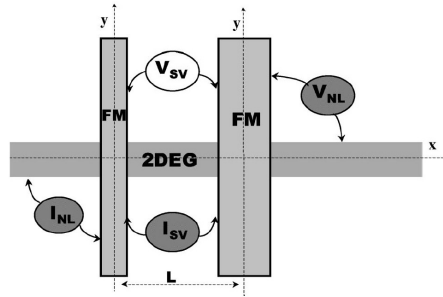
Spin Transport - *Spin-pol'd electrons* → *SC* → *Spin-pol'd electrons*

Spin FET structures :

Hall bar geometry



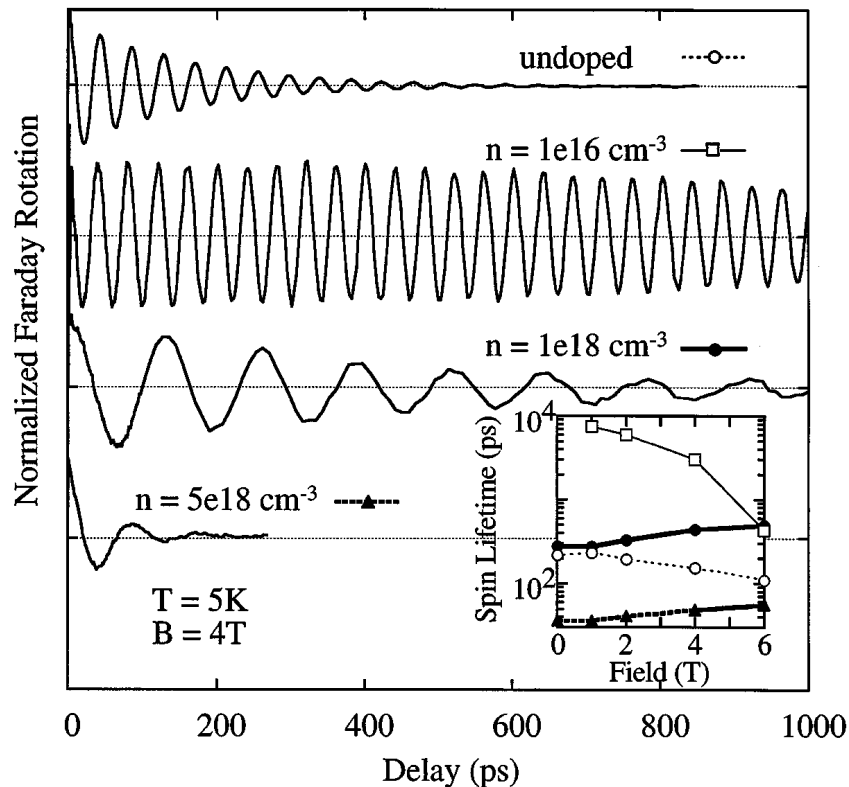
Asymmetric multi-terminal geometry



Structures	Spin polarization	Refs.
FM / 2DEG Hall-bar-type structures :		
86 nm NiFe / 25 nm AlGaSb / 15 nm InAs 2DEG / ... / GaAs	~ 1% @ 75 K	P. R. Hammar <i>et al.</i> , <i>Phys. Rev. Lett.</i> 83 , 203 (1999); <i>Phys. Rev. B</i> 61 , 7207 (2000).
NiFe / 750-6400 nm InAs QW / NiFe	Hall effect @ 4.2 K	F. G. Monzon and M. L. Roukes, <i>J. Magn. Magn. Mater.</i> 198-199 , 632 (1999).
FM / 2DEG asymmetric structures :		
NiFe & Co / InAs 2DEG / NiFe & Co	AMR @ 4.5 K	A. T. Filip <i>et al.</i> , <i>Phys. Rev. B</i> 62 , 9996 (2000).
60 nm NiFe / InAs 2DEG / GaAs	~ 0.2% @ < 10 K	C.-M. Hu <i>et al.</i> , <i>Phys. Rev. B</i> 63 , 125333 (2001).
Schottky (tunnel) diodes (FM / SC) :		
3.5 nm Fe / 2 nm Oxide / n-GaAs	~ 5% @ <RT	A. Filipe <i>et al.</i> , <i>Phys. Rev. Lett.</i> 80 , 2425 (1998).

Spin-Polarised Electrons in GaAs

> 100 μm spin diffusion length : *

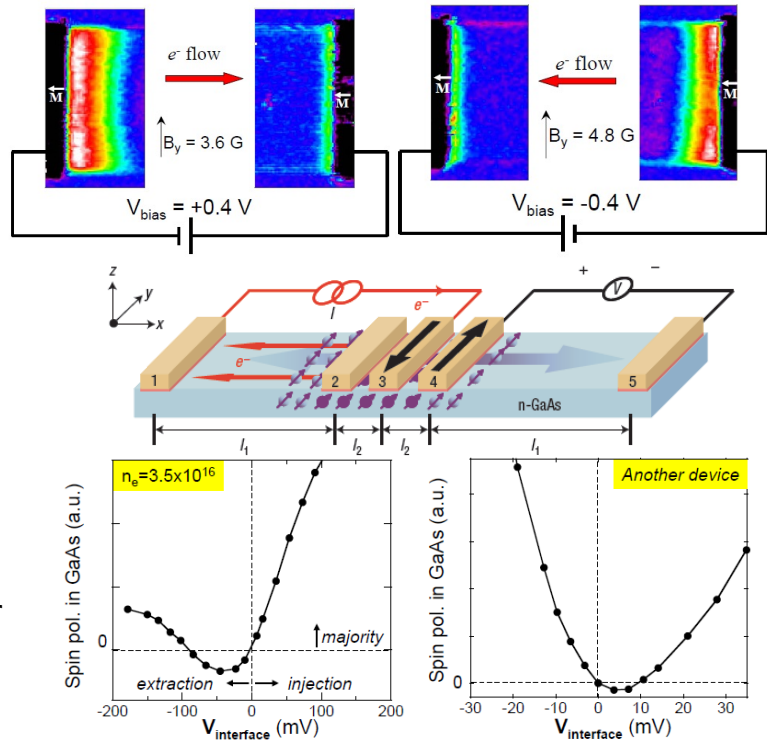


* J. M. Kikkawa and D. D. Awschalom, *Phys. Rev. Lett.* **80**, 4313 (1998).



Spin Transport Measurements in GaAs

- Experimental studies have shown that spin injection can be achieved leading to a majority spin accumulation.
- Spin injection / extraction has been observed using both optical* and electrical** techniques.
- A bias dependant polarisation inversion has been observed, the origin of which remains unknown.
- Knowledge of the mechanism(s) responsible for the polarisation inversion required for the development of future devices.

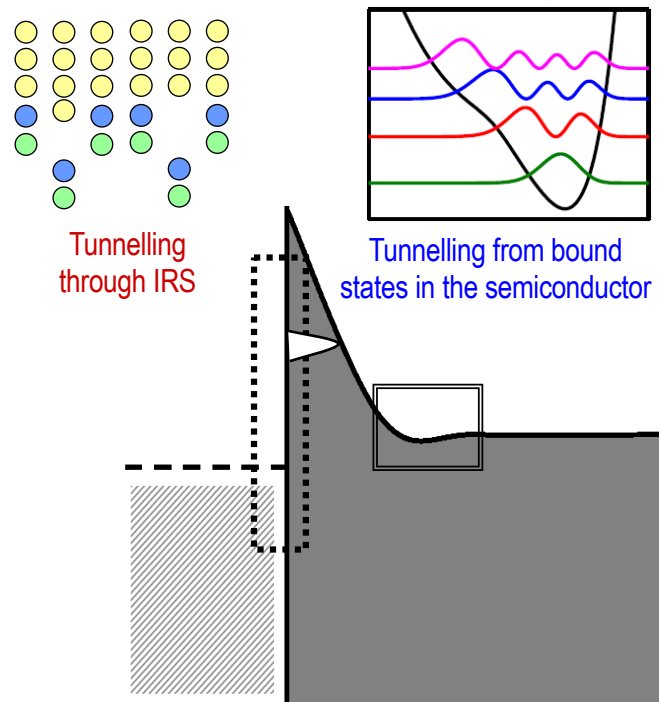


* S.A. Crooker *et al.*, *Science* **309**, 2191 (2005);
 ** X. Lou *et al.*, *Nature Phys.* **3**, 197 (2007).



Possible Origins of Spin Polarisation Reversal

- There are two promising candidates to explain the polarisation inversion:
 - Tunnelling through interface resonance states (IRS).*
 - Tunnelling from bound states in the semiconductor.**
- It has been shown that the contribution arising from bound states can be varied through control of the doping profile.
- The strength and position of IRS is sensitive to the atomic interface structure.*

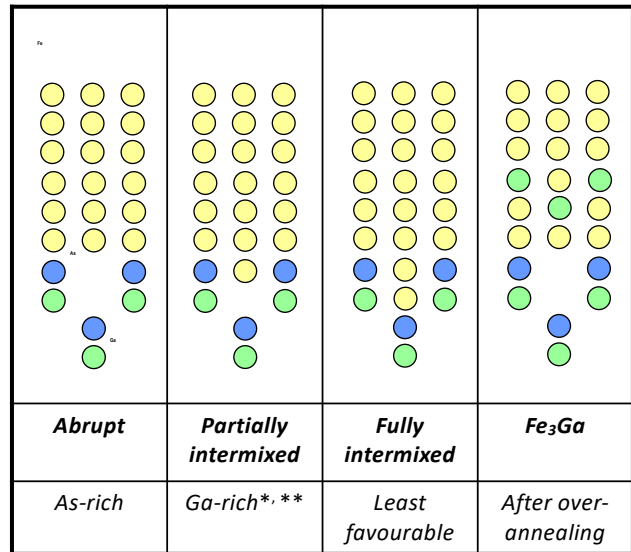


* S Honda *et al.*, *J. Phys. D: Appl. Phys.* **43**, 135002 (2010);
 ** H. Dery and L.J. Sham, *Phys. Rev. Lett.* **98**, 046602 (2007).



Fe / GaAs (001) Interface Structures

- There are several proposals for the interface structure of Fe / GaAs (001) films.
- Calculations suggest that the abrupt interface is energetically favourable for As-terminated surfaces (often used to limit diffusion).
- Previous calculations predict that minority carrier interface states lie 0.3 eV below the top of the Schottky barrier.
- *These are yet to be observed experimentally.*
- Calculations are yet to be performed for inter-atomic spacings measured experimentally.

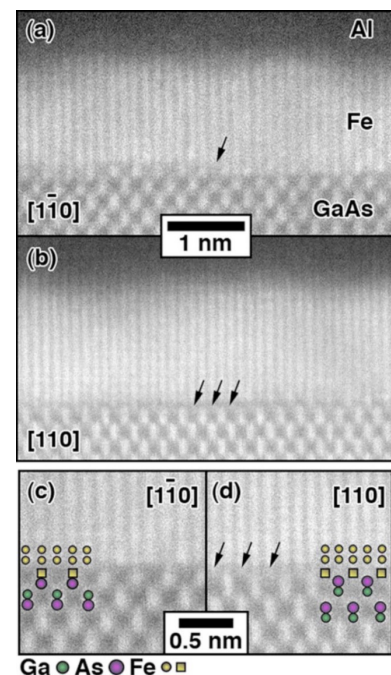
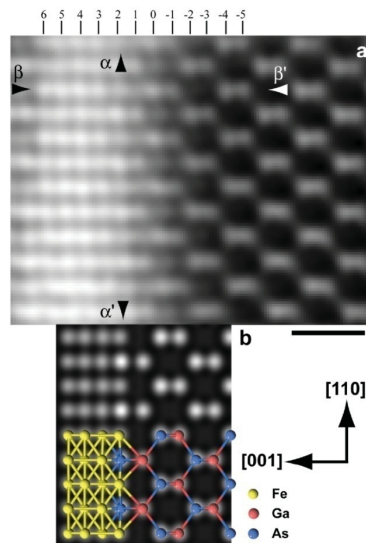


* T. J. Zega *et al.*, *Phys. Rev. Lett.* **96**, 196101 (2006);
 ** J. M. LeBau *et al.*, *Appl. Phys. Lett.* **93**, 121909 (2008).



Previous Experimental Observations

- There have been two previous reports on experimental observations of the Fe/GaAs interface. *,**
- The two studies reported different interfacial structures.
- **Both reports did not observe the abrupt interface.**
- Experimental values for the Schottky barrier height range from ***, **** eV.

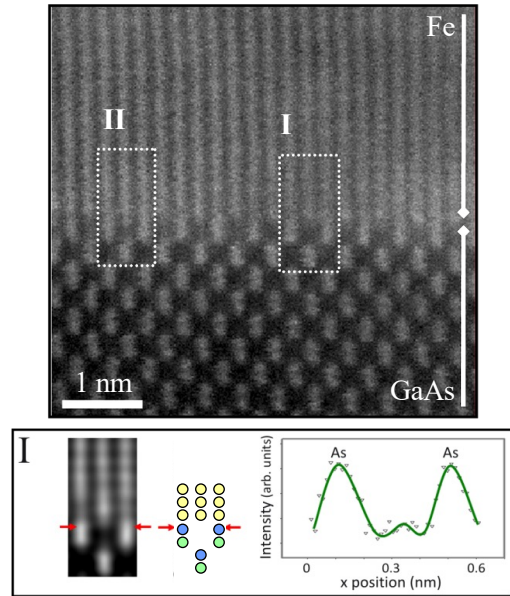


* T. J. Zega *et al.*, *Phys. Rev. Lett.* **96**, 196101 (2006);
 ** J. M. LeBau *et al.*, *Appl. Phys. Lett.* **93**, 121909 (2008);
 *** H. Kurebayashi *et al.*, *Appl. Phys. Lett.* **91**, 102114 (2007);
 **** B. T. Jonker *et al.*, *J. Appl. Phys.* **81**, 4362 (1997).



HAADF STEM Observation on Fe/GaAs Interfaces

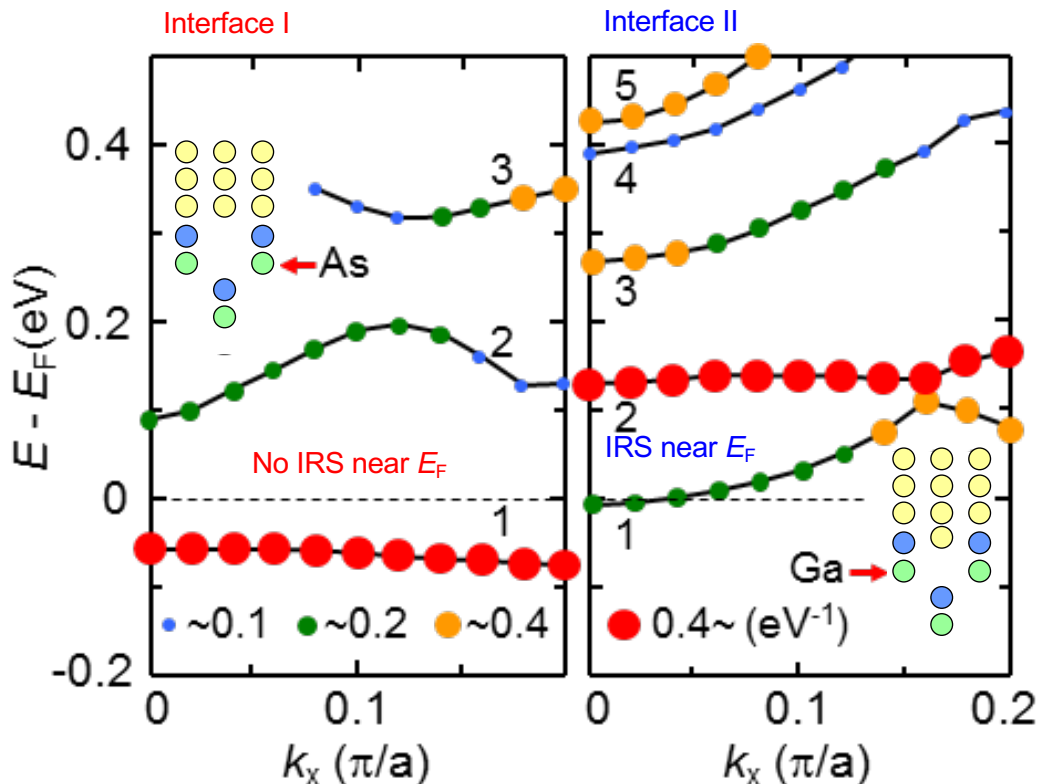
- The figure shows an **unfiltered** HAADF-STEM image the Fe / GaAs interface.
- Two different interfacial structures are observed.
 - Abrupt (first report) **
 - Partially mixed (as reported previously) *
- Analysis of the intensity profiles (z-contrast) taken across the interfaces suggest that Fe is responsible for the partially mixing.
- From the areas observed the film is ~ 95% abrupt.



* L. R. Fleet et al., *IEEE Trans. Magn.*, **47**, 2756 (2011);
 ** L. R. Fleet et al., *Phys. Rev. B* **87**, 024401 (2012).



Peak Positions of IRSs

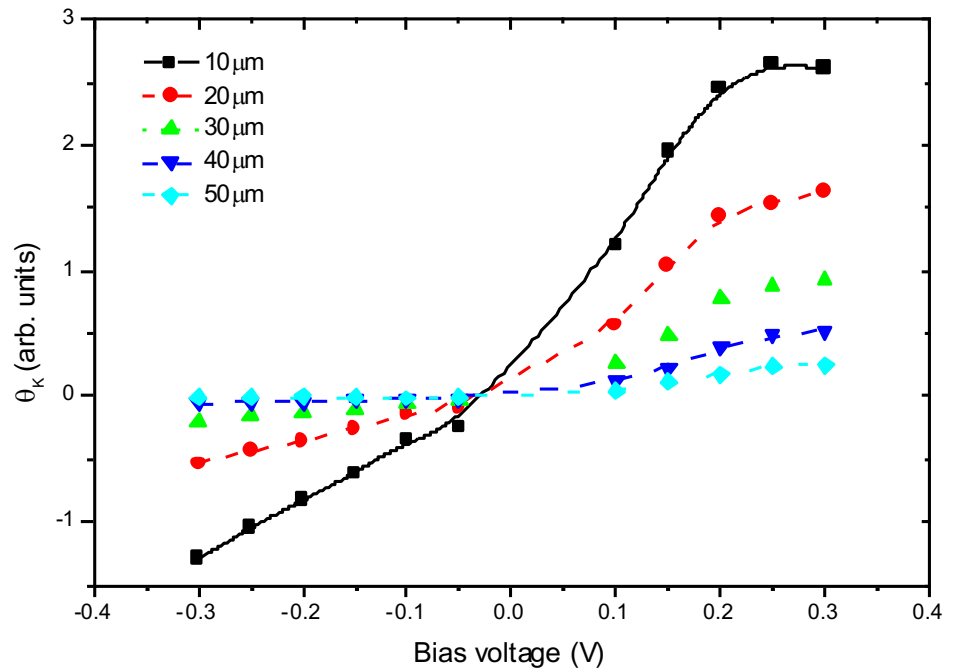


* L. R. Fleet et al., *Phys. Rev. B* **87**, 024401 (2012).



Bias Dependence

- No spin polarisation reversal induced by a bias voltage.
→ Agrees with calculations.



Rashba Effect for Gating

Gate operation in a spin FET : *

For the modulation of spin-polarised electrons in a semiconductor, the spin-orbit interaction Hamiltonian can be derived from the Dirac equations :

$$H_{SO} = \frac{q\hbar^2}{4m^2c^2} (\vec{\sigma} \cdot [\vec{E} \times \vec{p}])$$

where q , \hbar , m , c , $\vec{\sigma}$, \vec{E} and \vec{p} are the electron charge, Planck constant, electron mass, speed of light, Pauli matrices, electric field and electron momentum, respectively. By comparison with the Rashba Hamiltonian $H_R = \eta_{SO} (\vec{\sigma} \times \vec{k}) \cdot \vec{v}$ (\vec{k} : wave vector and \vec{v} : unit vector perpendicular to plane),

$$H_R = \frac{q\hbar^2}{4m^2c^2} (\vec{\sigma} \cdot [\vec{E} \times \vec{p}]) = \frac{q\hbar^2}{4m^2c^2} \frac{V_G}{d} (\vec{\sigma} \times \vec{k}) \cdot \vec{v}$$

The spin-orbit interaction constant η_{SO} can be obtained by using a gate voltage V_G and distance between an electron path and a gate length d :

$$\eta_{SO} = \frac{q\hbar^2}{4m^2c^2} \frac{V_G}{d}$$



Gate Dimensions

Gate operation in a spin FET : *

For commonly-used InGaAs 2DEG, a 180° phase shift can be achieved for a separation between an injector and a detector :

$$l = \frac{\Delta\theta \hbar^2}{2m^* \eta_{SO}} \approx \mu\text{m},$$

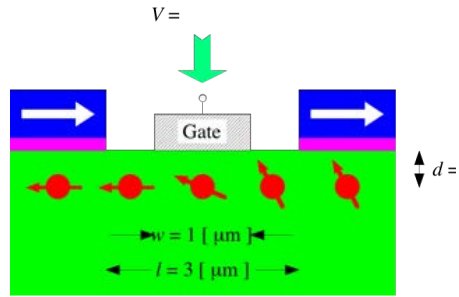
and gate length :

$$w = \frac{\hbar^2}{2m^* \eta_{SO}} \approx \mu\text{m}.$$

The corresponding electric field required is estimated to be

$$\frac{V_G}{d} = \frac{4m^{*2}c^2\eta_{SO}}{q\hbar^2} \approx 4.3 \times 10^{10} \text{ V/m} \text{ (} m^* \text{ is the electron effective mass).}$$

This provides $d \sim 1 \text{ nm}$ and $V_G \sim 43 \text{ V}$.



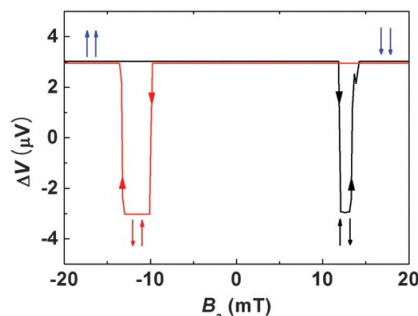
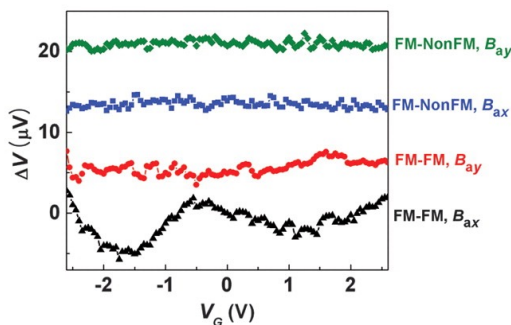
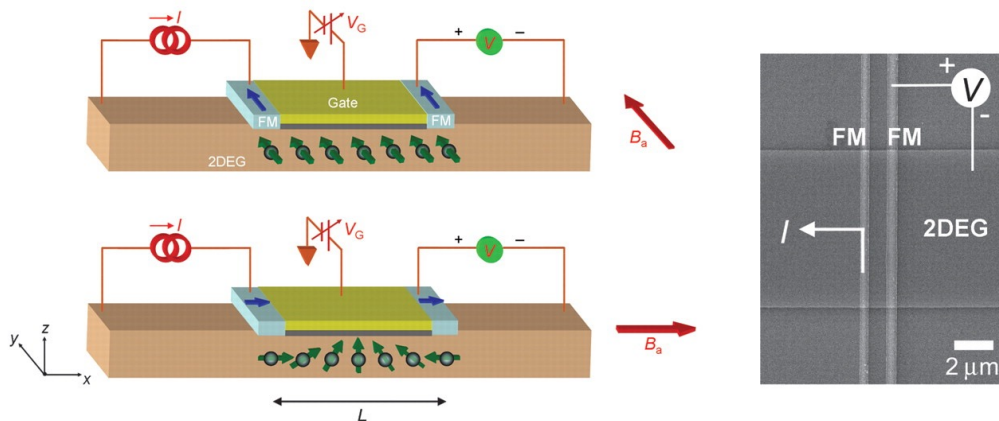
These values are very difficult to realise with present nano-fabrication techniques and requires a further improvement of the spin-orbit interaction constant η_{SO} .

* A. Hirohata et al., *J. Magn. Magn. Mater.* **509**, 166711 (2020).



Recent Demonstration of Spin FET Operation

Gate operation in a NiFe / InGaAs / NiFe spin FET : *



* H. C. Koo et al., *Science* **325**, 1515 (2009).



Theoretical Studies - FM → SC

FM / SC Interfaces :

Ohmic contacts :

- Diffusive process : 100 % spin polarisation in FM is crucial.
→ DMS, Heusler compounds and half-metallic FM as FM

G. Schmidt *et al.*, *Phys. Rev. B* **62**, R4790 (2000).

Schottky / tunnel barrier contacts :

- Ballistic process :

E. I. Rashba, *Phys. Rev. B* **62**, 16267 (2000).

P. Mavropoulos *et al.*, *Phys. Rev. B* **66**, 024416 (2002).

Spin coherence length :

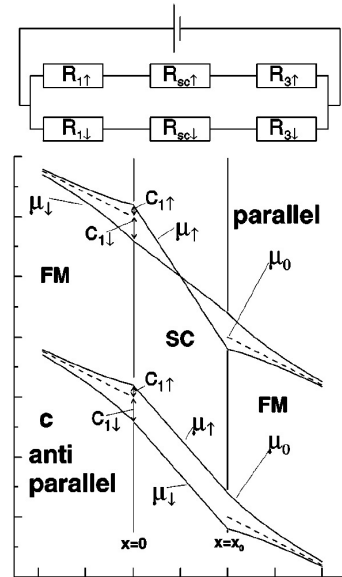
- Spin life time :

M. E. Flatté and G. Vignale, *Appl. Phys. Lett.* **78**, 1273 (2001).

Spin modulation :

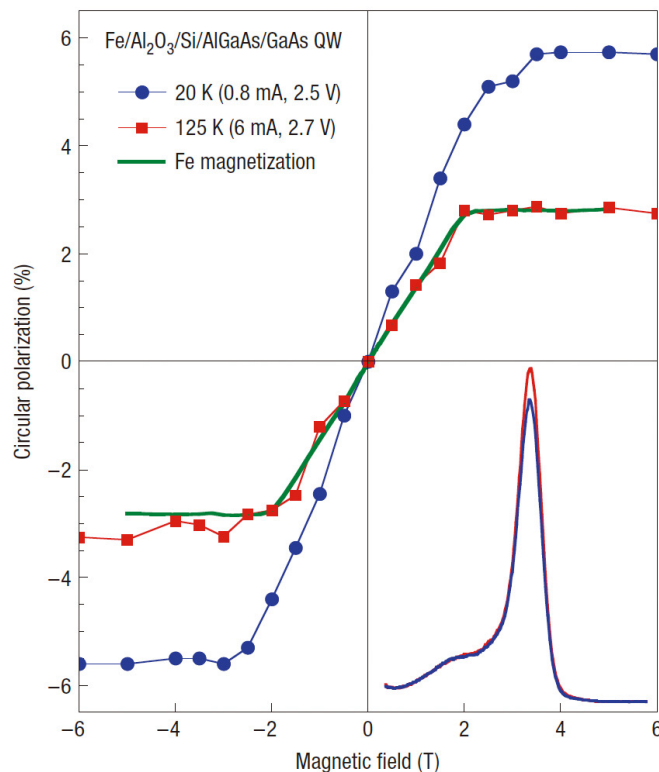
- Spin orientation \propto gate voltage

A. Bournel *et al.*, *Mater. Sci. Forum* **297**, 205 (1999).



Spin Injection into Si

Ballistic spin injection into Si : *

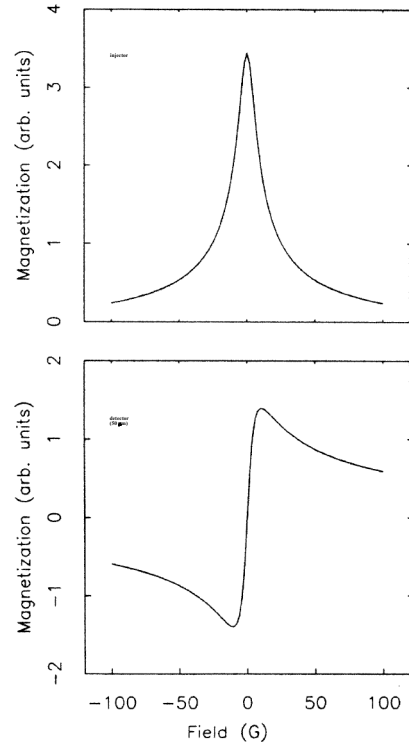
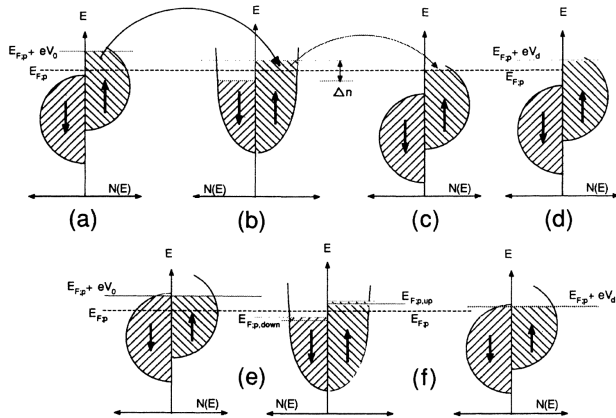
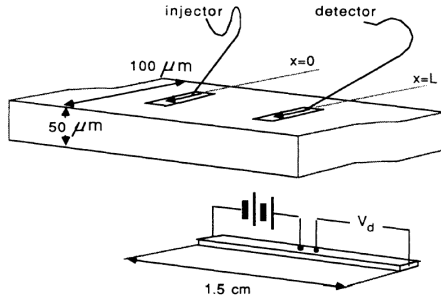


* B. T. Jonker *et al.*, *Nature Phys.* **3**, 542 (2007).



Johnson Transistors

All-metallic transistors : *

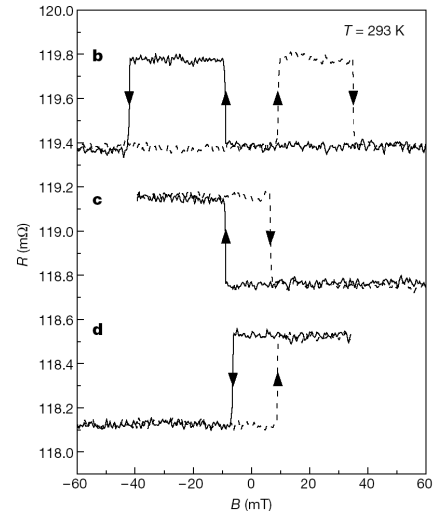
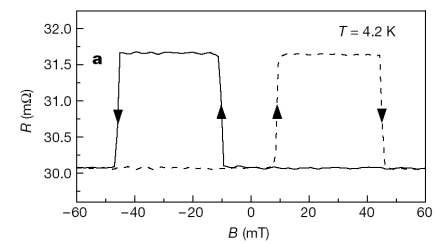
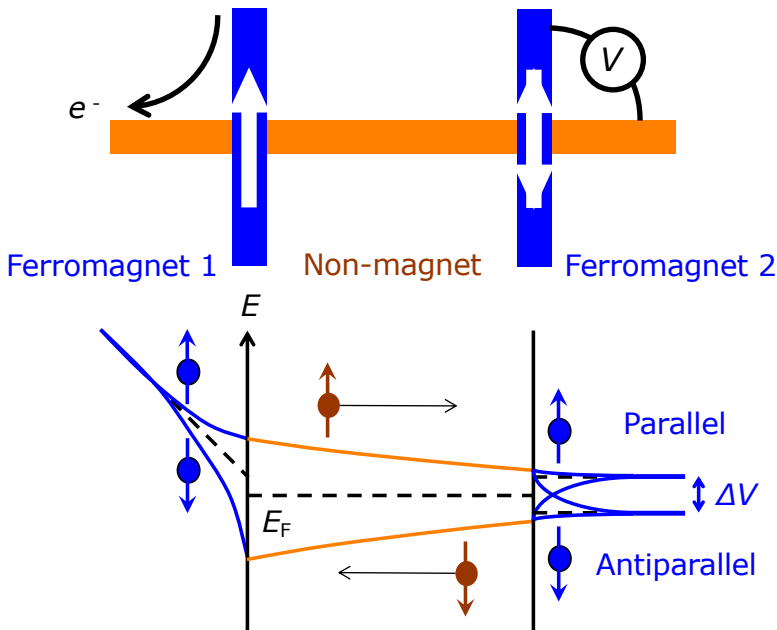


* M. Johnson and R. H. Silsbee, *Phys. Rev. Lett.* **56**, 1790 (1985), *Phys. Rev. B* **37**, 5312 (1988).



Recent Improvement

Lateral spin-valve structures with Co / Al / Co nano-wires : *



* F. J. Jedema *et al.*, *Nature* **410**, 345 (2001).



Generation of a Pure Spin Current

In a lateral spin-valve structure, a pure spin current can be generated : *

A spin current \vec{J}_s and a charge current \vec{J}_c can be expressed as

$$\vec{J}_s = -\frac{\hbar}{2e} (\vec{j}_\uparrow - \vec{j}_\downarrow),$$

$$\vec{J}_c = \vec{j}_\uparrow + \vec{j}_\downarrow.$$

These currents follow the diffusion equation. For the spin current, the spin diffusion equation is written as

$$\nabla^2(\mu_\uparrow - \mu_\downarrow) = \frac{1}{D\tau_{sf}}(\mu_\uparrow - \mu_\downarrow) \equiv \frac{1}{\lambda^2}(\mu_\uparrow - \mu_\downarrow),$$

where λ is the spin diffusion length ($= \sqrt{\quad}$) and τ_{sf} is the spin flip time.

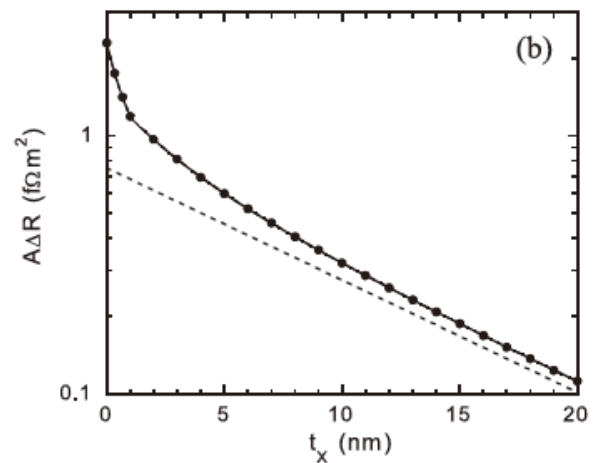
* A. Hirohata et al., *J. Magn. Magn. Mater.* **509**, 166711 (2020).



Spin Diffusion Length

Spin diffusion length determines the distance without spin flip : *

Materials	Spin diffusion length [nm] (300 K)	Resistivity [$\mu\Omega \cdot \text{cm}$] (300 K)
Al	350 ~ 600 (293 K)	3.2 ~ 9.1
Cu	350 \pm 50 (293 K)	2.9
Ag	132 ~ 152 (298 K)	4.9 ~ 5.5
Au	60 (293 K)	5.2
Pt	3.8 +0.7/-0.3	18 \pm 0.7
Ta	1.9 +0.3/-0.5	200 \pm 15
CoFe	6.2 +0.3/-0.7	20 \pm 1.3
NiFe	5.2 +1.8/-0.9	30 \pm 3
Co	7.7 +1.8/-2.2	25 \pm 2.4



$$\Lambda R_{NL} = 4 \frac{P^2 R_{FM}^2}{(1 - P^2)^2 R_{NM}} \frac{\exp\left(-\frac{d}{\lambda_{NM}}\right)}{\left[1 - \frac{2R_{FM}}{(1 - P^2)R_{NM}}\right]^2 - \exp\left(-\frac{2d}{\lambda_{NM}}\right)}$$

where $P = I_\uparrow - I_\downarrow / I_\uparrow + I_\downarrow$: current polarisation of FM, λ_{NM} : spin diffusion length in NM and $R_{NM} = \rho_N \lambda_N / w_N t_N$ and $R_{FM} = \rho_{FM} \lambda_{FM} / w_{FM} t_N$: NM and FM spin resistances.

• J. Bass and W. P. Pratt, Jr. *J. Phys.: Condens. Matter* **19**, 183201 (2007); G. Zahnd et al., *Phys. Rev. B* **98**, 174414 (2018);

** L. O'Brien et al., *Nat. Commun.* **5**, 3927 (2014).